

| L Number | Hits | Search Text | DB | Time stamp |
|----------|------|---|---|---------------------|
| 11 | 2 | ("6002147").PN. | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2002/11/07 16:40 |
| 12 | 2 | ("6298551").PN. | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2002/11/07 16:42 |
| 15 | 2 | ("5172301").PN. | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2002/11/07 16:45 |
| 16 | 2 | ("5920458").PN. | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2002/11/07 16:46 |
| 17 | 2 | ("5659458").PN. | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2002/11/07 16:46 |
| 18 | 2 | ("5467251").PN. | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2002/11/07 16:47 |
| 19 | 2 | ("5352926").PN. | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2002/11/07 16:50 |
| 20 | 2 | ("5468681").PN. | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2002/11/07 16:51 |
| 21 | 2 | ("6190941").PN. | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2002/11/07 16:52 |
| 22 | 2 | ("4509096").PN. | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2002/11/07 16:52 |
| 23 | 2 | ("5814535").PN. | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2002/11/07 17:14 |
| 24 | 347 | pin with solder adj ball and 257/\$.ccls. | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2002/11/07 17:32 |
| 25 | 765 | akram.in. and semiconductor | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2002/11/07 17:34 |

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| - | 2 | stack adj chip and 257/758.ccls. | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT | 2002/11/05 11:05 |
| - | 20 | ("4551629" "4770640" "4868712" "4875139" "4943539" "4983533" "5019943" "5110298" "5202754" "5235672" "5247423" "5266833" "5270261" "5285571" "5315147" "5506450" "5517754" "5571754" "5585674" "5623166").PN. | USPAT | 2002/11/05 11:01 |
| - | 8 | ("3859127" "5103287" "5104820" "5126231" "5196378" "5259925" "5266833" "5397916").PN. | USPAT | 2002/11/05 11:04 |
| - | 6 | stack adj chip and electrode and 257/686.ccls. | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; | 2002/11/05 11:06 |
| - | 19 | stack adj chip and electrode and 257/\$.ccls. | US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; | 2002/11/05 11:08 |
| - | 4 | stack adj chip and electrode and 361/\$.ccls. | US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; | 2002/11/05 11:10 |
| - | 3 | stack adj chip and electrode and 29/\$.ccls. | US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; | 2002/11/05 11:44 |
| - | 3185 | 257/758 | US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; | 2002/11/05 12:36 |
| - | 1776 | 257/686 | US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; | 2002/11/06 10:59 |
| - | 1728 | 257/698 | US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; | 2002/11/06 13:57 |
| - | 1 | "6472738" | US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; | 2002/11/06 14:16 |
| - | 5 | ("5404581" "5614442" "5614743" "5635762" "6075712").PN. | USPAT | 2002/11/06 13:57 |
| - | 206 | hole and semiconductor adj chip and 257/686.ccls. | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; | 2002/11/06 18:05 |
| - | 2204 | 257/737 | US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; | 2002/11/06 18:41 |

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| - | 3 | ("6339237").PN. | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2002/11/06 19:19 |
| - | 2651 | (257/391,392,331,282,280,295).CCLS. | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2002/11/07 16:34 |
| - | 1 | "5293072".PN. | USPAT | 2002/11/07 13:24 |